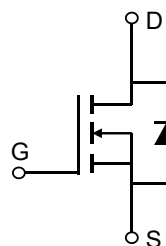


### Description

#### Features

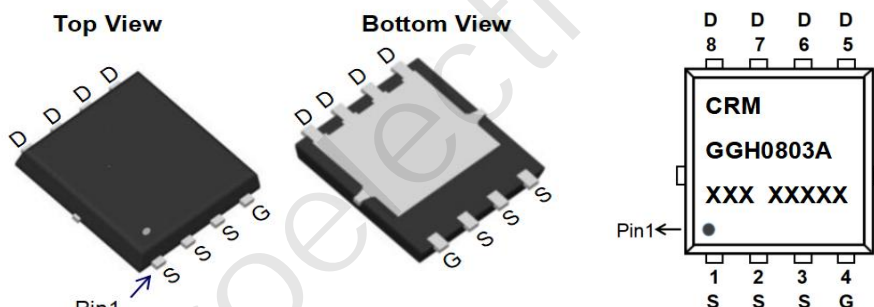
- 80V, 160A  
 $R_{DS(ON)}$  Typ = 2.6mΩ @  $V_{GS} = 10V$
- Advanced Split Gate Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- 100% UIS TESTED!
- 100%  $\Delta V_d$ s TESTED!



Schematic Diagram

#### Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

#### Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGH0803A	CRMGGH0803A	PDFN5x6-8L	TAPING	13"	5000	60000

#### Absolute Maximum Ratings (@ $T_J = 25^\circ C$ unless otherwise specified)

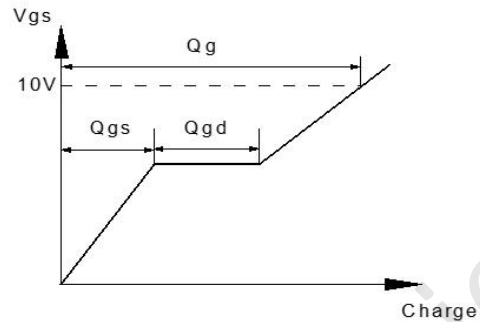
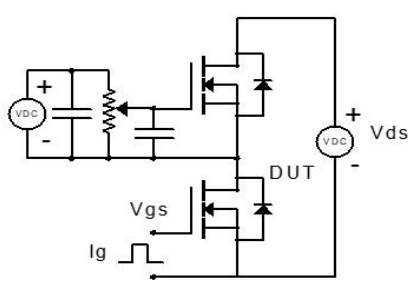
Symbol	Parameter	Value	Units
$V_{DS}$	Drain-to-Source Voltage	80	V
$V_{GS}$	Gate-to-Source Voltage	±20	V
$I_D$	Continuous Drain Current	$T_C = 25^\circ C$	160
		$T_C = 100^\circ C$	96
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>	640	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>	462	mJ
$P_D$	Power Dissipation	$T_C = 25^\circ C$	156
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.8	$^\circ C/W$
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55 to 150	$^\circ C$

### Electrical Characteristics (T<sub>J</sub> = 25°C unless otherwise specified)

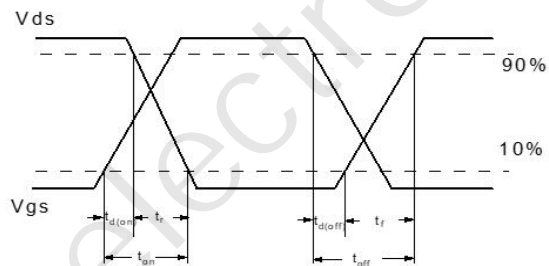
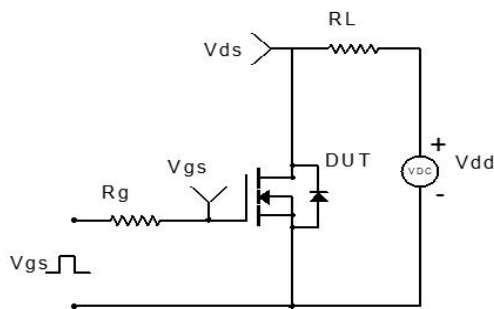
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	80	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V	-	-	1.0	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2	3	4	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(3)</sup>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	-	2.6	3.4	mΩ
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 40V, f = 1MHz	-	6059	-	pF
C <sub>oss</sub>	Output Capacitance		-	1696	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	46	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 to 10V V <sub>DS</sub> = 40V, I <sub>D</sub> = 20A	-	88	-	nC
Q <sub>gs</sub>	Gate Source Charge		-	38	-	nC
Q <sub>gd</sub>	Gate Drain("Miller") Charge		-	22	-	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On DelayTime	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 40V I <sub>D</sub> = 20A, R <sub>GEN</sub> = 6Ω	-	28	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	32	-	ns
t <sub>d(off)</sub>	Turn-Off DelayTime		-	65	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	40	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	160	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	640	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I <sub>F</sub> = 20A, di/dt = 100A/us	-	70	-	ns
Qrr	Body Diode Reverse Recovery Charge		-	142	-	nC

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
  2. E<sub>AS</sub> condition: Starting T<sub>J</sub>=25°C, V<sub>DD</sub>=40V, V<sub>G</sub>=10V, R<sub>G</sub>=25ohm, L=0.5mH, I<sub>AS</sub>=43A
  3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 0.5%.

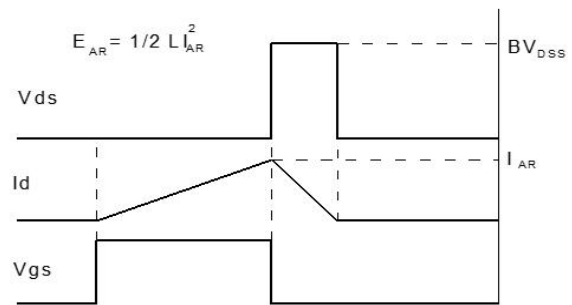
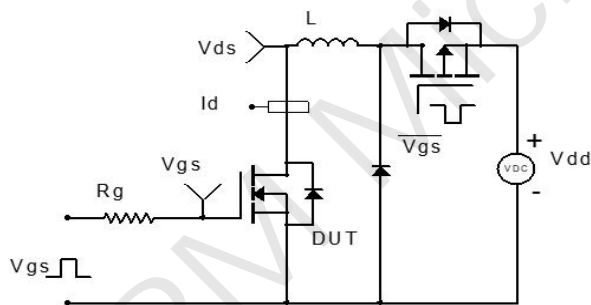
**Test Circuit**



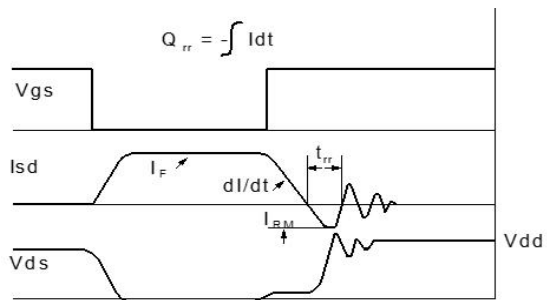
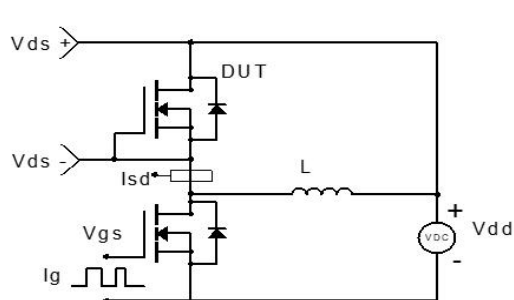
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

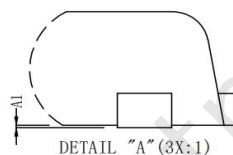
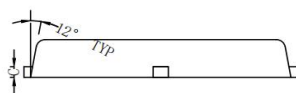
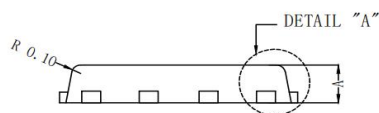
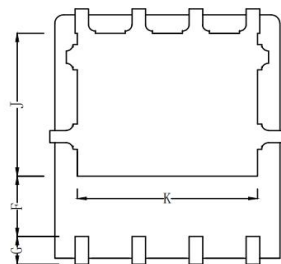
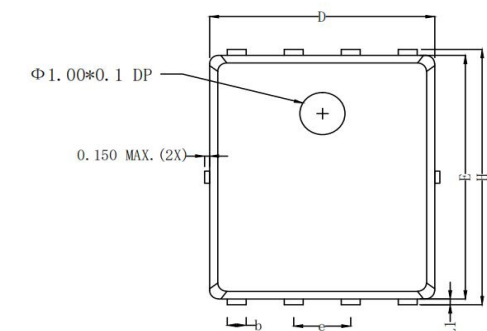


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

### Package Mechanical Data(PDFN5x6-8L)




Dimensions In Millimeterer			
Symbol	MIN	TYP	MAX
A	0.90	1.00	1.10
A1	0.00	0.03	0.05
b	0.25	0.30	0.35
c	0.254 REF		
D	4.80	4.90	5.00
F	1.35 REF		
E	5.65	5.75	5.85
e	1.27 BSC		
H	5.90	6.00	6.10
L1	0.10	0.13	0.16
G	0.55 REF		
K	4.00 REF		
J	3.45 REF		

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